

# Data and signal line chokes

Common-mode chokes, ring core 0.47 ... 4.7 mH, 300 ... 600 mA, 60 °C

Series/Type: B82792C2

Date: April 2008

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## Data and signal line chokes

Common-mode chokes, ring core

<u>SMD</u>

Rated voltage 42 V AC/80 V DC Rated inductance 0.47 mH to 4.7 mH Rated current 300 mA to 600 mA

#### Construction

- Current-compensated ring core quad choke
- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Bifilar winding

#### Features

- Suitable for reflow soldering
- RoHS-compatible

## Function

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly.

#### Applications

- Telecom applications
- RF equipment

#### Terminals

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

#### Marking

- Marking on component: Manufacturer, ordering code inductance, date of manufacture (YYMMD)
- Minimum data on reel: Manufacturer, ordering code, L value and tolerance, quantity, date of packing

#### Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 500 pcs./reel





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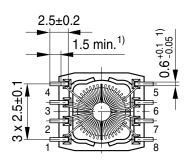
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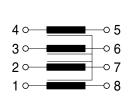
## Data and signal line chokes

#### Common-mode chokes, ring core

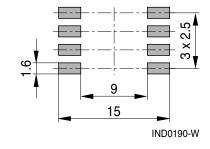
<u>SMD</u>

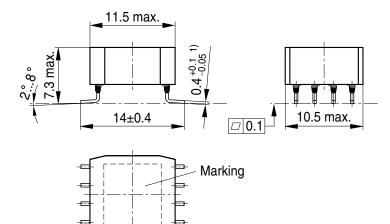
#### Dimensional drawing and pin configuration











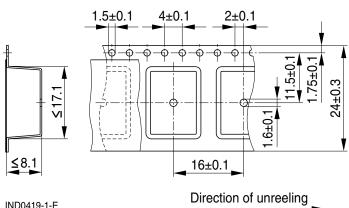
1) Soldering area

IND0189-Q-E

Dimensions in mm

#### **Taping and packing**

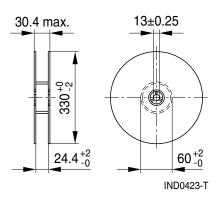
Blister tape



IND0419-1-E

Dimensions in mm

Reel



Please read Cautions and warnings and Important notes at the end of this document.

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#### Technical data and measuring conditions

Rated voltage V <sub>R</sub>	42 V AC (50/60 Hz) / 80 V DC		
Rated temperature T <sub>R</sub>	60 °C		
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature		
Rated inductance L <sub>R</sub>	$\begin{array}{l} \mbox{Measured with Agilent 4284A at 50 mV, 20 °C} \\ \mbox{Measuring frequency: } L_R \leq 1 \mbox{ mH} = 100 \mbox{ kHz} \\  L_R > 1 \mbox{ mH} = 10 \mbox{ kHz} \\ \mbox{Inductance is specified per winding.} \end{array}$		
Inductance tolerance	–30%/+50% at 20 °C		
Inductance decrease $\Delta L/L_0$	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C		
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 50 mV, 20 °C, typical values Measuring frequency: $L_R \le 1 \text{ mH} = 100 \text{ kHz}$ $L_R > 1 \text{ mH} = -10 \text{ kHz}$		
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding		
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 $\pm$ 5) °C, (3 $\pm$ 0.3) s Wetting of soldering area $\geq$ 95% (to IEC 60068-2-58)		
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)		
Climatic category	40/125/56 (to IEC 60068-1)		
Storage conditions (packaged)	–25 °C … +40 °C, ≤75% RH		
Weight	Approx. 2 g		

## Characteristics and ordering codes

L <sub>R</sub>	L <sub>stray,typ</sub>	I <sub>R</sub>	R <sub>typ</sub>	V <sub>test</sub>	Ordering code
mH	nH	mA	mΩ	V DC, 2 s	
0.47	200	600	220	750	B82792C2474N315
1.0	200	500	170	750	B82792C2105N365
4.7	300	300	700	750	B82792C2475N365

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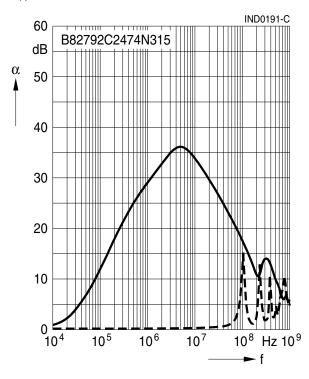
<u>SMD</u>

**Insertion loss**  $\alpha$  (typical values at  $|Z| = 50 \Omega$ , 20 °C)

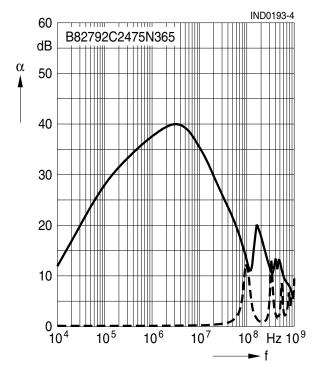
asymmetrical, all branches in parallel (common mode)

- - - - - symmetrical (differential mode)

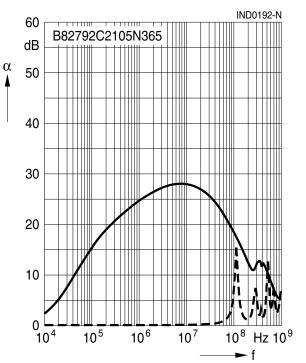
 $L_{B} = 0.47 \text{ mH}$ 



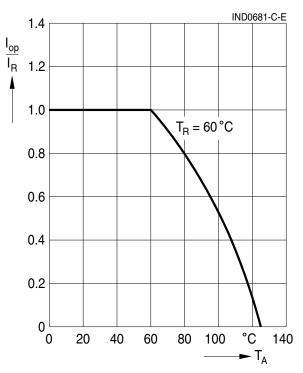




L<sub>R</sub> = 1.0 mH



Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature



Please read *Cautions and warnings* and *Important notes* at the end of this document.



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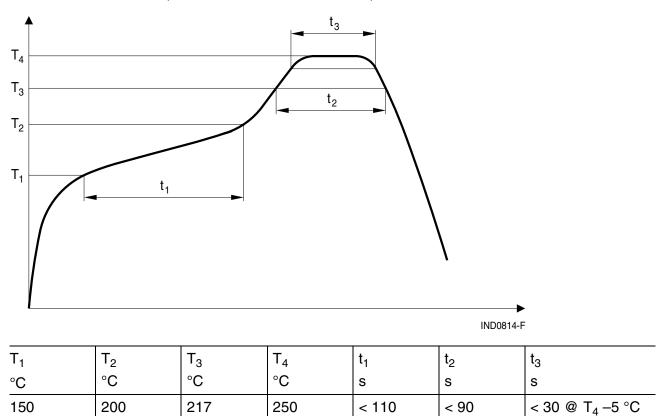
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## Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



Time from 25 °C to  $T_4$ : max 300 s Maximal numbers of reflow cycles: 3





#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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